VEMD8080

Vishay Semiconductors





www.vishay.com

DESCRIPTION

VEMD8080 is a high speed and high sensitive PIN photodiode with enhanced sensitivity for visible light. It is a low profile surface-mount device (SMD) including the chip with a 4.5 mm² sensitive area detecting visible and near infrared radiation.

FEATURES

- Package type: surface-mount
- Package form: top view
- Dimensions (L x W x H in mm): 4.8 x 2.5 x 0.48
- Radiant sensitive area (in mm²): 4.5
- 0.48 mm low profile package
- · Enhanced sensitivity for visible light
- Suitable for visible and near infrared radiation
- · Fast response times
- Angle of half sensitivity: $\phi = \pm 65^{\circ}$
- Floor life: 168 h, MSL 3, according to J-STD-020
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- High speed photo detector
- Wearables

PRODUCT SUMMARY

COMPONENT	I _{ra} (μΑ) φ (deg)		λ _{0.1} (nm)		
VEMD8080	28	± 65	350 to 1100		

Note

• Test conditions see table "Basic Characteristics"

ORDERING INFORMATION					
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM		
VEMD8080	Tape and reel	MOQ: 5000 pcs, 5000 pcs/reel	Top view		

Note

• MOQ: minimum order quantity

ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Reverse voltage		V _R	20	V
Junction temperature		Тj	85	°C
Operating temperature range		T _{amb}	-40 to +85	°C
Storage temperature range		T _{stg}	-40 to +85	°C
Soldering temperature	According to reflow solder profile Fig. 8	T _{sd}	260	°C
Thermal resistance junction-to-ambient		R _{thJA}	350	K/W
ESD safety HBM	± 2000 V, 1.5 kΩ, 100 pF, 3 pulses	ESD _{HBM}	≥2	kV



HALOGEN FREE <u>GREEN</u> (5-2008) www.vishay.com

VEMD8080 Vishay Semiconductors

BASIC CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	I _F = 50 mA	V _F	-	1.2	1.6	V
Breakdown voltage	I _R = 100 μA, E = 0	V _(BR)	20	-	-	V
Reverse dark current	V _R = 10 V, E = 0	I _{ro}	-	0.2	10	nA
Diode capacitance	$V_{R} = 0 V, f = 1 MHz, E = 0$	CD	-	47	-	pF
	$V_{R} = 3 V, f = 1 MHz, E = 0$	CD	-	17	40	pF
Open circuit voltage	$E_e = 1 \text{ mW/cm}^2$, $\lambda = 950 \text{ nm}$	Vo	-	320	-	mV
Temperature coefficient of V_o	$E_e = 1 \text{ mW/cm}^2$, $\lambda = 950 \text{ nm}$	TK _{Vo}	-	-3.0	-	mV/K
Short circuit current	$E_e = 1 \text{ mW/cm}^2$, $\lambda = 950 \text{ nm}$	l _k	-	32	-	μA
Temperature coefficient of ${\sf I}_{\sf k}$	$E_e = 1 \text{ mW/cm}^2$, $\lambda = 950 \text{ nm}$	TK _{lk}	-	0.1	-	%/K
Reverse light current	$E_e = 1 \text{ mW/cm}^2$, $\lambda = 850 \text{ nm}$, $V_R = 5 \text{ V}$	I _{ra}	23	28	33	μA
	$E_e = 0.25 \text{ mW/cm}^2$, $\lambda = 525 \text{ nm}$, $V_R = 5 \text{ V}$	I _{ra}	3.4	4.4	5.3	μA
Angle of half sensitivity		φ	-	± 65	-	deg
Wavelength of peak sensitivity		λ _p	-	850	-	nm
Range of spectral bandwidth		λ _{0.1}	-	350 to 1100	-	nm
Rise time	$V_R = 10 \text{ V}, \text{ R}_L = 1 \text{ k}\Omega, \lambda = 830 \text{ nm}$	t _r	-	70	-	ns
Fall time	$V_R = 10 \text{ V}, \text{ R}_L = 1 \text{ k}\Omega, \lambda = 830 \text{ nm}$	t _f	-	70	-	ns

BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

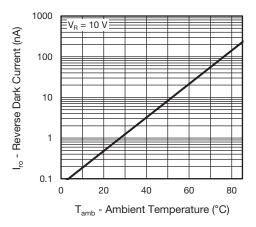


Fig. 1 - Reverse Dark Current vs. Ambient Temperature

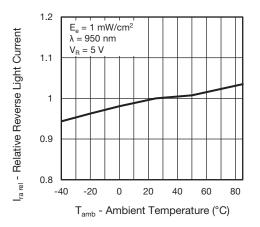
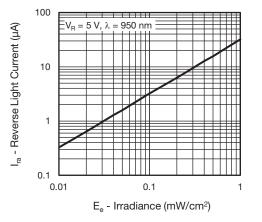


Fig. 2 - Relative Reverse Light Current vs. Ambient Temperature

2

For technical questions, contact: <u>detectortechsupport@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>

Vishay Semiconductors



www.vishay.com

Fig. 3 - Reverse Light Current vs. Irradiance

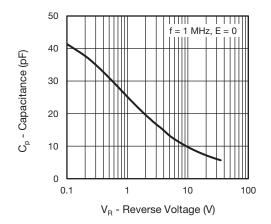


Fig. 4 - Diode Capacitance vs. Reverse Voltage

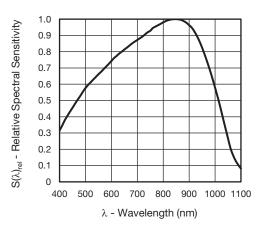


Fig. 5 - Relative Spectral Sensitivity vs. Wavelength

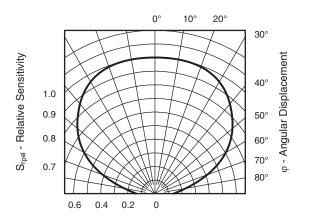


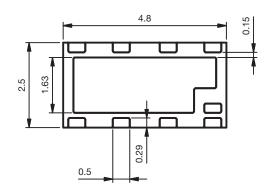
Fig. 6 - Relative Sensitivity vs. Angular Displacement

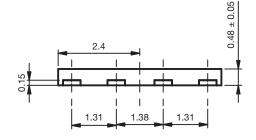
3

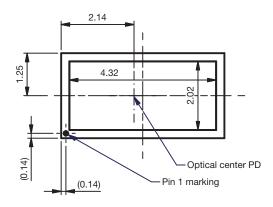




PACKAGE DIMENSIONS in millimeters

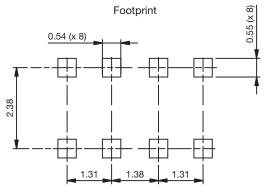






Drawing number: 6.550-5354.01-4 Issue: 1; 20.04.2018

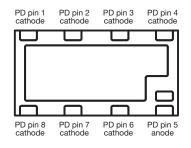
Technical drawings according to DIN specification.



Not indicated tolerances \pm 0.1 mm

Pinning top view				
PD pin 8 cathode	PD pin 7 cathode	PD pin 6 cathode	PD pin 5 anode	
PD pin 1 cathode	PD pin 2 cathode	PD pin 3 cathode	PD pin 4 cathode	

Pinning bottom view



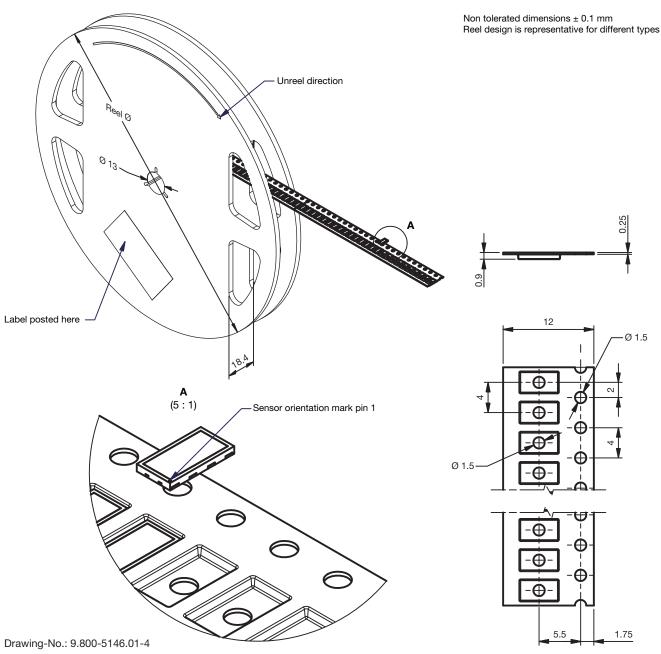
4

VEMD8080



TAPE AND REEL DIMENSIONS in millimeters

Vishay Semiconductors

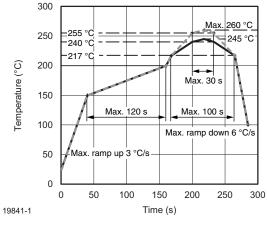


Issue: 1; 20.04.2018

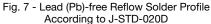
5



SOLDER PROFILE



www.vishay.com



DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

Time between soldering and removing from MBB must not exceed the time indicated in J-STD-020:

Moisture sensitivity: level 3

Floor life: 168 h

Conditions: $T_{amb} < 30\ ^\circ C,\ RH < 60\ \%$

DRYING

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or recommended conditions:

192 h at 40 °C (+ 5 °C), RH < 5 % or 96 h at 60 °C (+ 5 °C), RH < 5 %



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.